

### GENERAL DESCRIPTION

The SGM2592 is a single channel power distribution switch. The switch controlled by the EN pin operates from 2.5V to 6V supply voltage. It can be used in USB power distribution applications.

The SGM2592 has integrated current limit function to protect the upstream power supply from damage during over-current or short-circuit condition. It also has the function of over-temperature protection.

The device is designed with soft-start circuit to cope with inrush currents when large capacitive loads are connected.

The SGM2592 further reduces the total solution size by integrating a 48Ω pull-down resistor for output discharge when the switch is shut down by EN.

SGM2592 is available in a Green SOT-23-5 package.

### FEATURES

- **High-side N-MOSFET**
- **On-Resistance: 65mΩ (TYP)**
- **Current Limit:**  
SGM2592AD: 1285mA  
SGM2592BD: 2370mA
- **Input Voltage Range: 2.5V to 6V**
- **Quiescent Current: 27μA (TYP)**
- **Shutdown Current: 0.26μA (TYP)**
- **Soft-Start Function**
- **Over-Temperature Protection**
- **Under-Voltage Lockout Protection for VIN**
- **No Reversed Leakage Current (Reverse Blocking)**
- **Quick Output Discharge**
- **1.3MΩ Pull-Down Resistor at EN Pin**
- **UL Recognized Component (File No. E532373\*)**
- **Available in a Green SOT-23-5 Package**

### APPLICATIONS

General Purpose Power Switching  
 USB Bus/Self-Powered Hub  
 USB Peripheral  
 ACPI Power Distribution  
 Smart Phone  
 LCD TV

### TYPICAL APPLICATION

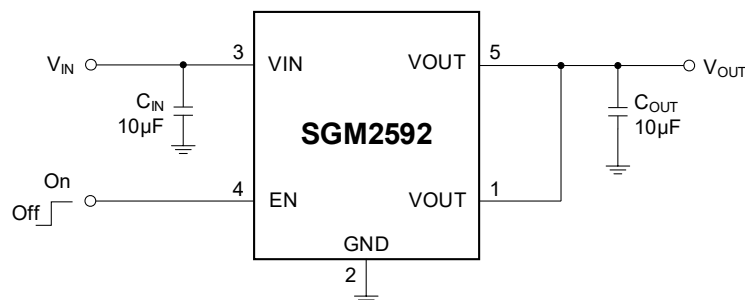


Figure 1. Typical Application Circuit

## PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM2592AD	SOT-23-5	-40°C to +125°C	SGM2592ADXN5G/TR	07RXX	Tape and Reel, 3000
SGM2592BD	SOT-23-5	-40°C to +125°C	SGM2592BDXN5G/TR	07SXX	Tape and Reel, 3000

## MARKING INFORMATION

NOTE: XX = Date Code.

**YYY X X**

— Date Code - Week  
— Date Code - Year  
— Serial Number

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

### ABSOLUTE MAXIMUM RATINGS

VIN.....	6.5V
All Other Pins.....	6V
Package Thermal Resistance	
SOT-23-5, $\theta_{JA}$ .....	191°C/W
SOT-23-5, $\theta_{JB}$ .....	46.4°C/W
SOT-23-5, $\theta_{JC}$ .....	91°C/W
Junction Temperature.....	+150°C
Storage Temperature Range .....	-65°C to +150°C
Lead Temperature (Soldering, 10s).....	+260°C
ESD Susceptibility	
HBM.....	2000V
CDM .....	1000V

## RECOMMENDED OPERATING CONDITIONS

Input Voltage Range .....	2.5V to 6V
EN Voltage Range .....	-0.3V to 5.5V
All Other Pins .....	0V to 5.5V
Operating Junction Temperature Range .....	-40°C to +125°C

## OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

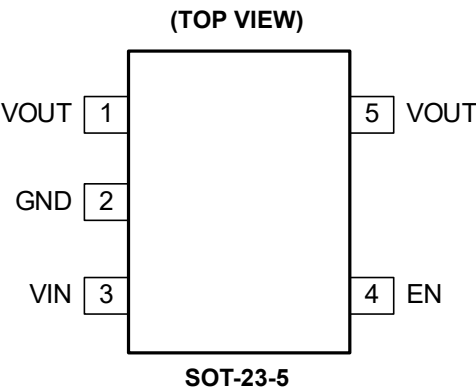
## ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

## DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATION



PIN DESCRIPTION

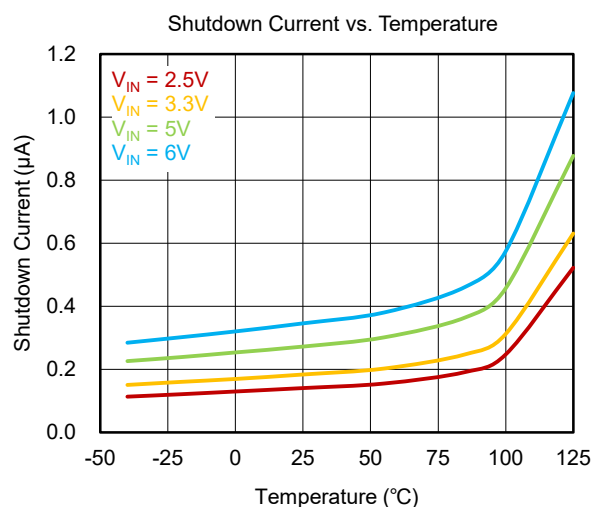
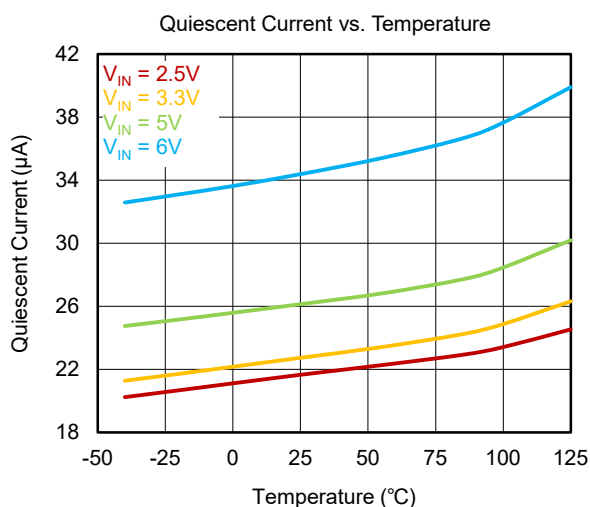
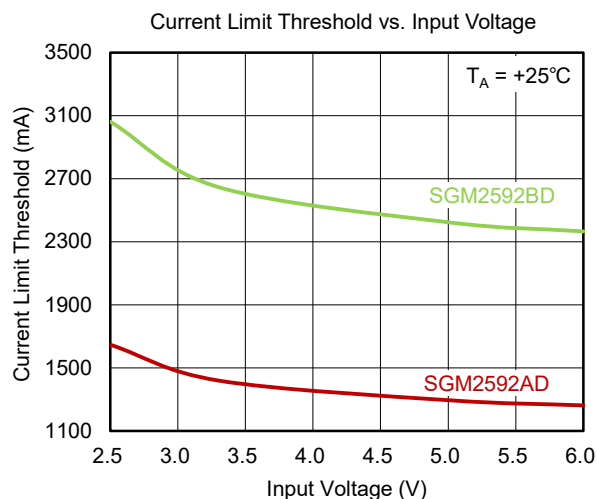
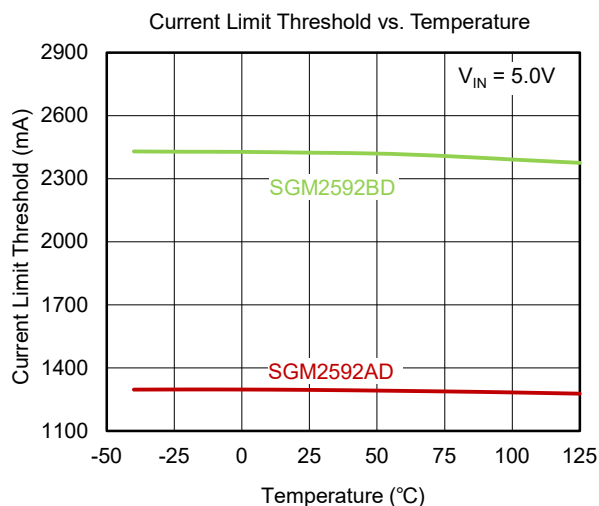
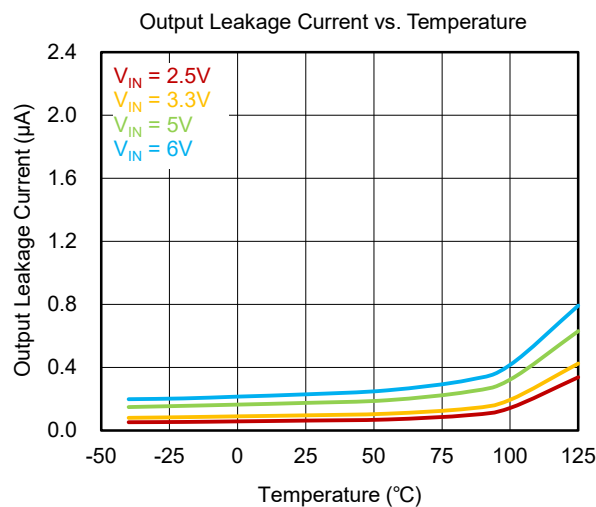
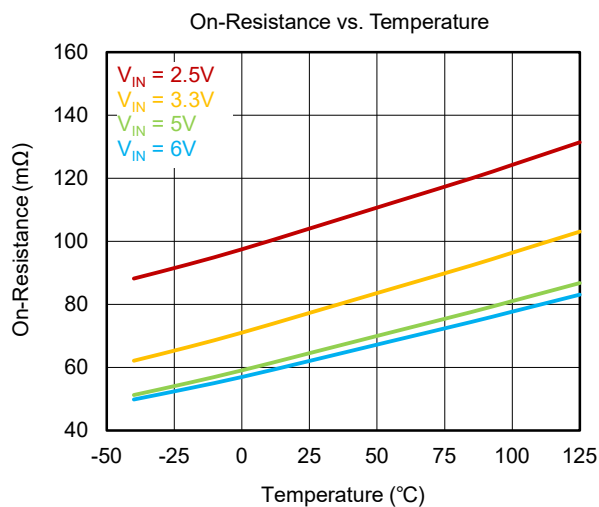
PIN	NAME	FUNCTION
1, 5	VOUT	Output Voltage.
2	GND	Ground.
3	VIN	Power Input Voltage.
4	EN	Chip Enable. Active-high for SGM2592. It has integrated a 1.3MΩ pull-down resistor at this pin.

## ELECTRICAL CHARACTERISTICS

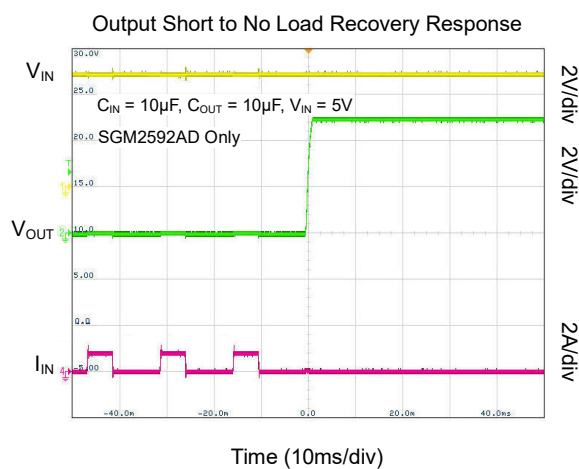
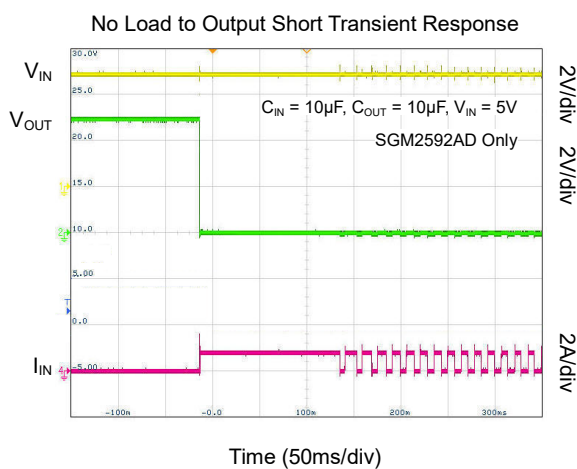
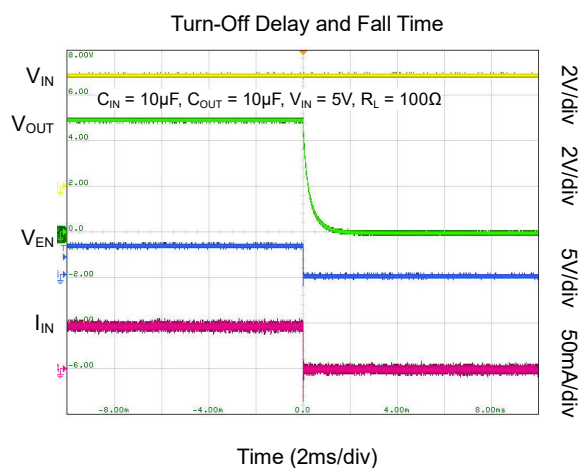
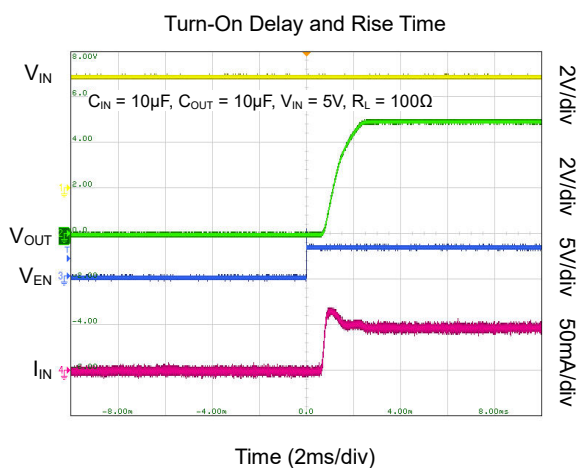
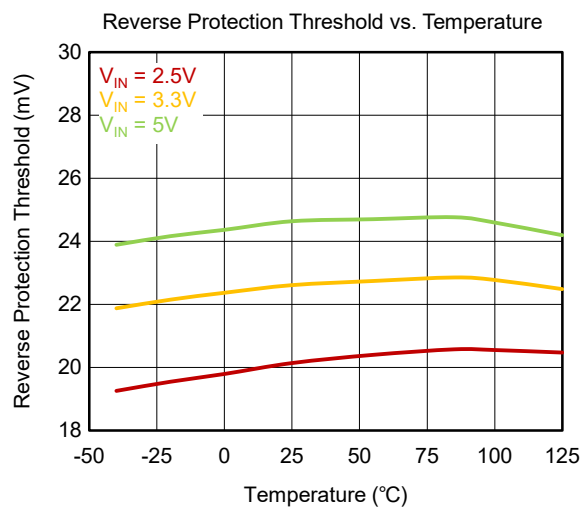
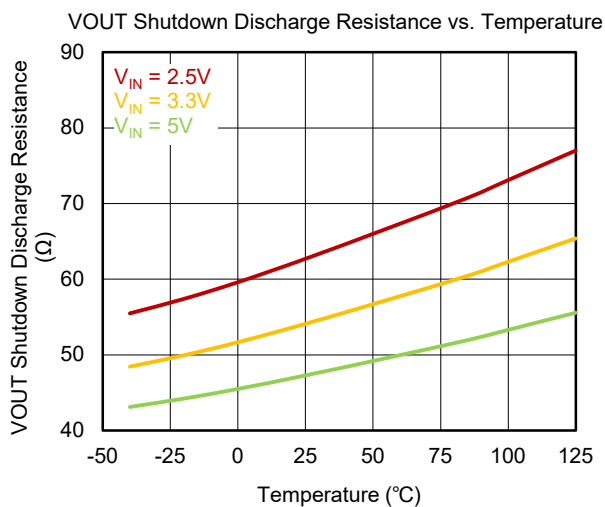
(T<sub>J</sub> = -40°C to +125°C, typical values are at T<sub>J</sub> = +25°C, V<sub>IN</sub> = 5V, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Voltage Range	V <sub>IN</sub>		2.5		6	V
Under-Voltage Lockout Threshold	V <sub>UVLO</sub>	V <sub>IN</sub> rising		2.23	2.4	V
	V <sub>UVLO_HYS</sub>	V <sub>IN</sub> falling		100		mV
Quiescent Current	I <sub>Q</sub>	Switch on, V <sub>OUT</sub> = open		27	60	μA
Shutdown Current	I <sub>SD</sub>	Switch off, V <sub>OUT</sub> = open		0.26	3	μA
Output Leakage Current	I <sub>LEAKAGE</sub>	Switch off, V <sub>OUT</sub> = 6V, V <sub>IN</sub> = 0V, T <sub>J</sub> = -40°C to +85°C		0.22	1.5	μA
		Switch off, V <sub>OUT</sub> = 6V, V <sub>IN</sub> = 0V, T <sub>J</sub> = -40°C to +125°C		0.22	6	
Enable Input Threshold Voltage	V <sub>IH</sub>		1.2			V
	V <sub>IL</sub>	T <sub>J</sub> = -40°C to +85°C			0.4	
		T <sub>J</sub> = -40°C to +125°C			0.3	
Pull-Down Resistor at EN Pin	R <sub>PULL_DOWN</sub>			1.3		MΩ
On-Resistance	R <sub>DS(on)</sub>	I <sub>OUT</sub> = 200mA	T <sub>J</sub> = -40°C to +85°C	65	98	mΩ
			T <sub>J</sub> = -40°C to +125°C	65	125	
Output Turn-On Delay Time	t <sub>ON</sub>	R <sub>L</sub> = 100Ω, C <sub>OUT</sub> = 0.1μF		1.1		ms
Output Turn-Off Delay Time	t <sub>OFF</sub>	R <sub>L</sub> = 100Ω, C <sub>OUT</sub> = 0.1μF		27		μs
Output Turn-On Rise Time	t <sub>R</sub>	R <sub>L</sub> = 100Ω, C <sub>OUT</sub> = 0.1μF		1.3		ms
Output Turn-Off Fall Time	t <sub>F</sub>	R <sub>L</sub> = 100Ω, C <sub>OUT</sub> = 0.1μF		13		μs
Current Limit Threshold	I <sub>LIM</sub>	SGM2592AD	T <sub>J</sub> = +25°C	1120	1285	mA
			T <sub>J</sub> = -40°C to +125°C	1110	1285	
		SGM2592BD	T <sub>J</sub> = +25°C	2125	2370	
			T <sub>J</sub> = -40°C to +125°C	2050	2370	
Reverse Protection Threshold	V <sub>REV</sub>	V <sub>OUT</sub> rising	5	24	42	mV
Reverse Protection Threshold Hysteresis	V <sub>REV_HYS</sub>			15		mV
V <sub>OUT</sub> Shutdown Discharge Resistance	R <sub>DIS</sub>	Switch off, sink 2mA into OUT		48		Ω
Thermal Shutdown Temperature	T <sub>SD</sub>	T <sub>J</sub> increasing		156		°C
Thermal Shutdown Hysteresis	T <sub>HYS</sub>			30		°C

## TYPICAL PERFORMANCE CHARACTERISTICS



## TYPICAL PERFORMANCE CHARACTERISTICS (continued)



FUNCTIONAL BLOCK DIAGRAM

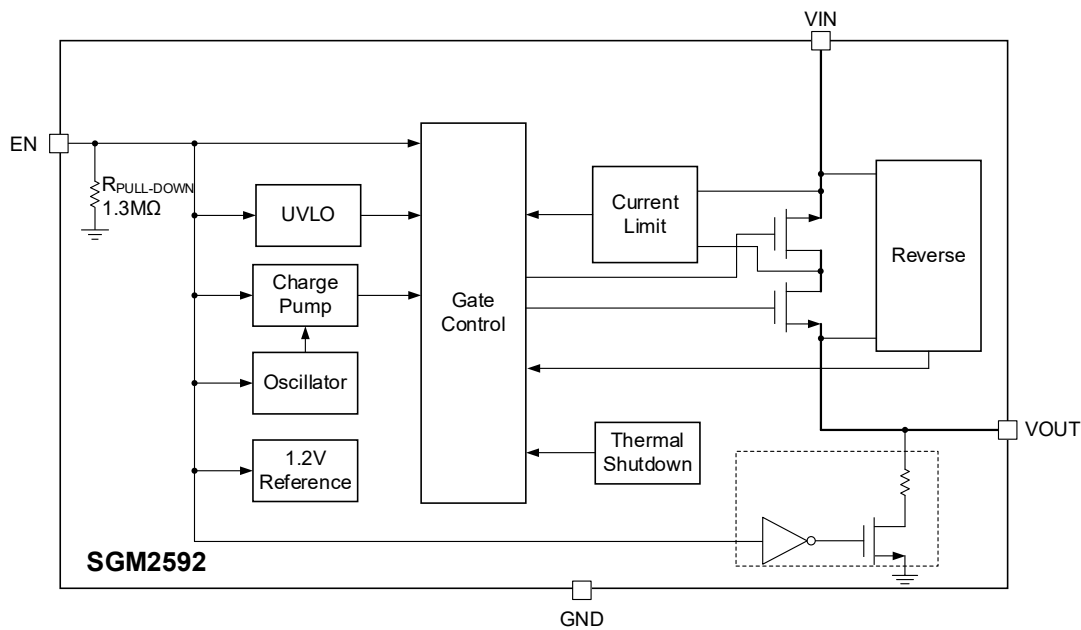


Figure 2. Block Diagram

TIMING DIAGRAM

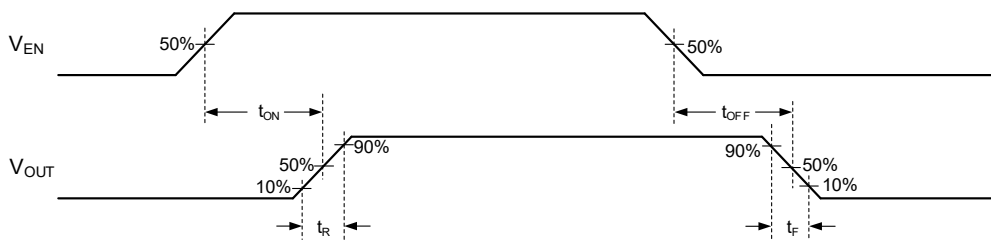


Figure 3. Switch Turn-On and Turn-Off Delay Times

## DETAILED DESCRIPTION

### Input and Output

VIN should be connected to the power source that is the power supply of the internal logic circuitry and loads. Normally, load current flows from VIN to VOUT. The output MOSFET and driver circuit are designed to allow the voltage of VOUT is higher than VIN, when the device is turned off.

### Thermal Shutdown (TSD)

The thermal shutdown threshold is +156°C with 30°C hysteresis.

### Soft-Start

The soft-start feature is used to limit inrush current during startup or hot-plug events so that the device can cope with inrush current when connected to large capacitive loads.

### Under-Voltage Lockout (UVLO)

If the voltage on VIN pin falls below its under-voltage lockout threshold, the device will be disabled. The device resumes operation when the power supply goes back above UVLO threshold.

### Current Limit and Short-Circuit Protection

The current limit protection circuit is designed to limit the output current to protect the upstream power supply. The typical current limit threshold is set internally to approximately 1.285A (SGM2592AD)/2.37A (SGM2592BD).

The current limit threshold is  $60\% \times I_{LIM}$  in short-circuit state. If the short-circuit state persists, the device will cycle on and off under thermal protection as a result of power dissipation.

### Reverse-Voltage Protection

When the output voltage exceeds the input voltage by 24mV (TYP), the device turns off the internal N-MOSFET to avoid the reverse current from the output to input. Its hysteresis voltage is 15mV (TYP).

### Output Discharge

The device integrates the output discharge feature. When the EN pin is pulled low (below  $V_{IL}$ ), a discharge resistance with a typical value of 48Ω is connected between the VOUT and GND. This resistance pulls down the output and prevents it from floating when the device is disabled.



## APPLICATION INFORMATION

### Power Dissipation

Assuming a given ambient temperature and an output current, the maximum allowable power dissipation is calculated by:

$$P_{D(MAX)} = \frac{T_{J(MAX)} - T_A}{\theta_{JA}} \quad (1)$$

where:

- ◆  $P_{D(MAX)}$  is the maximum power dissipation.
- ◆  $T_{J(MAX)}$  is the maximum operating junction temperature.
- ◆  $T_A$  is the operating ambient temperature.
- ◆  $\theta_{JA}$  is junction to air thermal impedance.

Please note that the thermal vias are placed under the exposed pad of the device, thus allowing for thermal dissipation away from the device.

### Supply Filter Capacitor

It is recommended to use a 10μF capacitor between VIN and GND close to the device pins. It can limit the voltage drop of the input supply. Larger  $C_{IN}$  can reduce voltage dip in high current applications. Without an input capacitor, short-circuit at the output will cause the input voltage to ring, which may destroy the chip's internal circuitry when the input transient voltage exceeds the absolute maximum supply voltage (6.5V).

### Output Filter Capacitor

It is recommended to use a low-ESR 10μF ceramic capacitor between VOUT and GND standard bypass methods to reduce EMI, improve the transient performance, and minimize negative effects of resistance and inductance between the bypass capacitor and the downstream connector. If the output port is connected to the load through a long cable, the parasitic inductance of the cable may cause voltage to ring, whose negative ringing may damage the chip, so an anti-parallel Schottky diode such as BAT54 is recommended to connect in parallel with the output.

### PCB Layout Guidelines

A reasonable PCB layout is critical to the stable performance of the device. For best results, follow the guidelines below.

- ◆ Keep the power traces as short and wide as possible, and use at least 2 ounces of copper.
- ◆ Placing a ground plane under all circuits to reduce resistance and inductance will improve DC and transient performances.
- ◆ Ensure that the input decoupling capacitors on VIN have a minimal trace length to VIN and GND.
- ◆ Place the output capacitors as close to the device as possible to minimize the effect of PCB parasitic inductance.

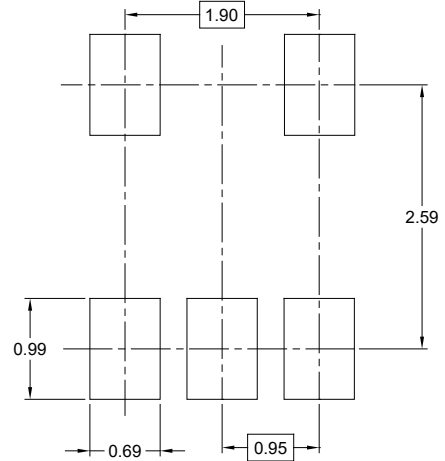
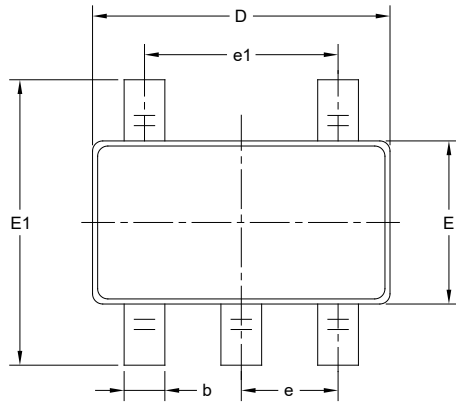
## REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

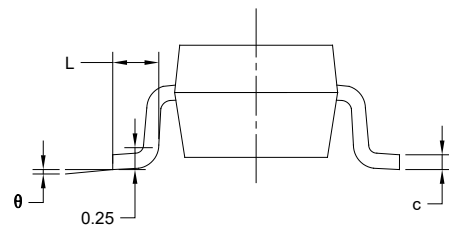
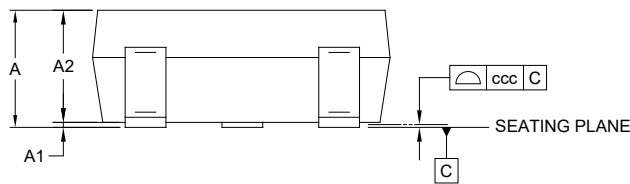
APRIL 2025 – REV.A.1 to REV.A.2	Page
Updated Typical Performance Characteristics section .....	6
Updated Current Limit and Short-Circuit Protection section .....	8
OCTOBER 2024 – REV.A to REV.A.1	Page
Added UL Recognized Component (File No. E532373*) .....	1
Changes from Original (JUNE 2024) to REV.A	Page
Changed from product preview to production data .....	All

## PACKAGE OUTLINE DIMENSIONS

### SOT-23-5



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	-	-	1.450
A1	0.000	-	0.150
A2	0.900	-	1.300
b	0.300	-	0.500
c	0.080	-	0.220
D	2.750	-	3.050
E	1.450	-	1.750
E1	2.600	-	3.000
e	0.950 BSC		
e1	1.900 BSC		
L	0.300	-	0.600
θ	0°	-	8°
ccc	0.100		

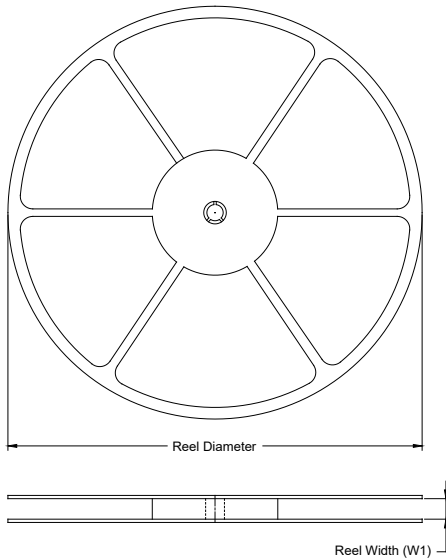
#### NOTES:

1. This drawing is subject to change without notice.
2. The dimensions do not include mold flashes, protrusions or gate burrs.
3. Reference JEDEC MO-178.

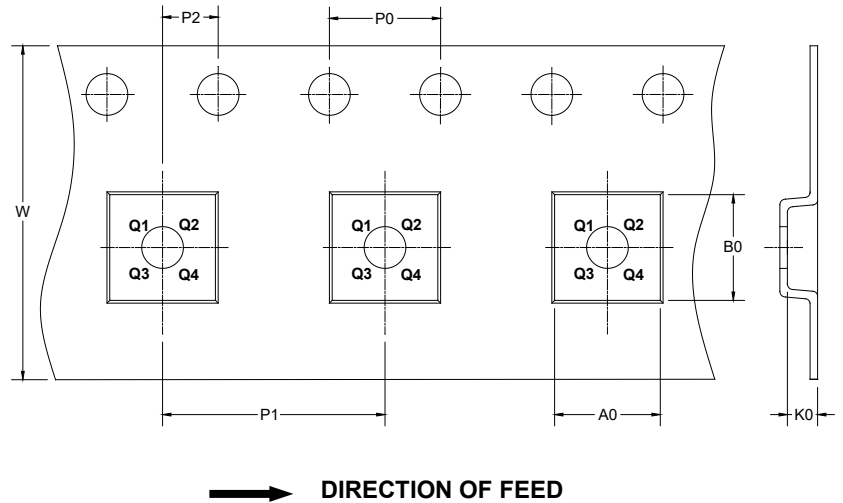
# PACKAGE INFORMATION

## TAPE AND REEL INFORMATION

### REEL DIMENSIONS



### TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

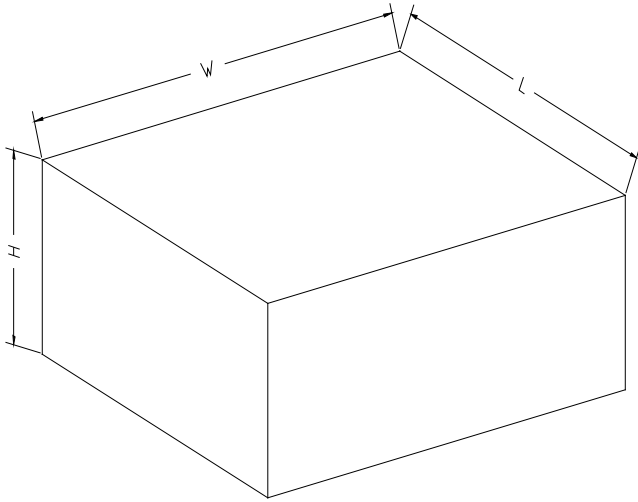
### KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3

DD0001

## PACKAGE INFORMATION

### CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

### KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18

DD0002